# Intel - 5SGXEA5N2F40C2L Datasheet

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## Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

## Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

| Details | |
|---|---|
| Product Status | Obsolete |
| Number of LABs/CLBs | 185000 |
| Number of Logic Elements/Cells | 490000 |
| Total RAM Bits | 46080000 |
| Number of I/O | 600 |
| Number of Gates | - |
| Voltage - Supply | 0.82V ~ 0.88V |
| Mounting Type | Surface Mount |
| Operating Temperature | 0°C ~ 85°C (TJ) |
| Package / Case | 1517-BBGA, FCBGA |
| Supplier Device Package | 1517-FBGA (40x40) |
| Purchase URL | https://www.e-xfl.com/product-detail/intel/5sgxea5n2f40c2l |

**Table 19. Single-Ended SSTL, HSTL, and HSUL I/O Standards Signal Specifications for Stratix V Devices (Part 2 of 2)**

| I/O Standard | $V_{IL(DC)}$ (V) | | $V_{IH(DC)}$ (V) | | $V_{IL(AC)}$ (V) | $V_{IH(AC)}$ (V) | $V_{OL}$ (V) | $V_{OH}$ (V) | $I_{ol}$ (mA) | $I_{oh}$ (mA) |
|---|---|---|---|---|---|---|---|---|---|---|
| | Min | Max | Min | Max | Max | Min | Max | Min | | |
| HSTL-18 Class I | — | $V_{REF}$ – 0.1 | $V_{REF}$ + 0.1 | — | $V_{REF}$ – 0.2 | $V_{REF}$ + 0.2 | 0.4 | $V_{CCIO}$ – 0.4 | 8 | –8 |
| HSTL-18 Class II | — | $V_{REF}$ – 0.1 | $V_{REF}$ + 0.1 | — | $V_{REF}$ – 0.2 | $V_{REF}$ + 0.2 | 0.4 | $V_{CCIO}$ – 0.4 | 16 | –16 |
| HSTL-15 Class I | — | $V_{REF}$ – 0.1 | $V_{REF}$ + 0.1 | — | $V_{REF}$ – 0.2 | $V_{REF}$ + 0.2 | 0.4 | $V_{CCIO}$ – 0.4 | 8 | –8 |
| HSTL-15 Class II | — | $V_{REF}$ – 0.1 | $V_{REF}$ + 0.1 | — | $V_{REF}$ – 0.2 | $V_{REF}$ + 0.2 | 0.4 | $V_{CCIO}$ – 0.4 | 16 | –16 |
| HSTL-12 Class I | –0.15 | $V_{REF}$ – 0.08 | $V_{REF}$ + 0.08 | $V_{CCIO}$ + 0.15 | $V_{REF}$ – 0.15 | $V_{REF}$ + 0.15 | 0.25* $V_{CCIO}$ | 0.75* $V_{CCIO}$ | 8 | –8 |
| HSTL-12 Class II | –0.15 | $V_{REF}$ – 0.08 | $V_{REF}$ + 0.08 | $V_{CCIO}$ + 0.15 | $V_{REF}$ – 0.15 | $V_{REF}$ + 0.15 | 0.25* $V_{CCIO}$ | 0.75* $V_{CCIO}$ | 16 | –16 |
| HSUL-12 | — | $V_{REF}$ – 0.13 | $V_{REF}$ + 0.13 | — | $V_{REF}$ – 0.22 | $V_{REF}$ + 0.22 | 0.1* $V_{CCIO}$ | 0.9* $V_{CCIO}$ | — | — |

**Table 20. Differential SSTL I/O Standards for Stratix V Devices**

| I/O Standard | $V_{CCIO}$ (V) | | | $V_{SWING(DC)}$ (V) | | $V_{X(AC)}$ (V) | | | $V_{SWING(AC)}$ (V) | |
|---|---|---|---|---|---|---|---|---|---|---|
| | Min | Typ | Max | Min | Max | Min | Typ | Max | Min | Max |
| SSTL-2 Class I, II | 2.375 | 2.5 | 2.625 | 0.3 | $V_{CCIO}$ + 0.6 | $V_{CCIO}/2$ – 0.2 | — | $V_{CCIO}/2$ + 0.2 | 0.62 | $V_{CCIO}$ + 0.6 |
| SSTL-18 Class I, II | 1.71 | 1.8 | 1.89 | 0.25 | $V_{CCIO}$ + 0.6 | $V_{CCIO}/2$ – 0.175 | — | $V_{CCIO}/2$ + 0.175 | 0.5 | $V_{CCIO}$ + 0.6 |
| SSTL-15 Class I, II | 1.425 | 1.5 | 1.575 | 0.2 | *(1)* | $V_{CCIO}/2$ – 0.15 | — | $V_{CCIO}/2$ + 0.15 | 0.35 | — |
| SSTL-135 Class I, II | 1.283 | 1.35 | 1.45 | 0.2 | *(1)* | $V_{CCIO}/2$ – 0.15 | $V_{CCIO}/2$ | $V_{CCIO}/2$ + 0.15 | $2(V_{IH(AC)} - V_{REF})$ | $2(V_{IL(AC)} - V_{REF})$ |
| SSTL-125 Class I, II | 1.19 | 1.25 | 1.31 | 0.18 | *(1)* | $V_{CCIO}/2$ – 0.15 | $V_{CCIO}/2$ | $V_{CCIO}/2$ + 0.15 | $2(V_{IH(AC)} - V_{REF})$ | — |
| SSTL-12 Class I, II | 1.14 | 1.2 | 1.26 | 0.18 | — | $V_{REF}$ –0.15 | $V_{CCIO}/2$ | $V_{REF}$ + 0.15 | –0.30 | 0.30 |

**Note to Table 20:**

(1) The maximum value for $V_{SWING(DC)}$ is not defined. However, each single-ended signal needs to be within the respective single-ended limits ($V_{IH(DC)}$ and $V_{IL(DC)}$).

**Table 21. Differential HSTL and HSUL I/O Standards for Stratix V Devices (Part 1 of 2)**

| I/O Standard | $V_{CCIO}$ (V) | | | $V_{DIF(DC)}$ (V) | | $V_{X(AC)}$ (V) | | | $V_{CM(DC)}$ (V) | | | $V_{DIF(AC)}$ (V) | |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| | Min | Typ | Max | Min | Max | Min | Typ | Max | Min | Typ | Max | Min | Max |
| HSTL-18 Class I, II | 1.71 | 1.8 | 1.89 | 0.2 | — | 0.78 | — | 1.12 | 0.78 | — | 1.12 | 0.4 | — |
| HSTL-15 Class I, II | 1.425 | 1.5 | 1.575 | 0.2 | — | 0.68 | — | 0.9 | 0.68 | — | 0.9 | 0.4 | — |

**Table 21. Differential HSTL and HSUL I/O Standards for Stratix V Devices (Part 2 of 2)**

| I/O Standard | $V_{CCIO}$ (V) | | | $V_{DIF(DC)}$ (V) | | $V_{X(AC)}$ (V) | | | $V_{CM(DC)}$ (V) | | | $V_{DIF(AC)}$ (V) | |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| | Min | Typ | Max | Min | Max | Min | Typ | Max | Min | Typ | Max | Min | Max |
| HSTL-12 Class I, II | 1.14 | 1.2 | 1.26 | 0.16 | $V_{CCIO}$ + 0.3 | — | 0.5* $V_{CCIO}$ | — | 0.4* $V_{CCIO}$ | 0.5* $V_{CCIO}$ | 0.6* $V_{CCIO}$ | 0.3 | $V_{CCIO}$ + 0.48 |
| HSUL-12 | 1.14 | 1.2 | 1.3 | 0.26 | 0.26 | 0.5*$V_{CCIO}$ – 0.12 | 0.5* $V_{CCIO}$ | 0.5*$V_{CCIO}$ + 0.12 | 0.4* $V_{CCIO}$ | 0.5* $V_{CCIO}$ | 0.6* $V_{CCIO}$ | 0.44 | 0.44 |

**Table 22. Differential I/O Standard Specifications for Stratix V Devices (7)**

| I/O Standard | $V_{CCIO}$ (V) (10) | | | $V_{ID}$ (mV) (8) | | | $V_{ICM(DC)}$ (V) | | | $V_{OD}$ (V) (6) | | | $V_{OCM}$ (V) (6) | | |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| | Min | Typ | Max | Min | Condition | Max | Min | Condition | Max | Min | Typ | Max | Min | Typ | Max |
| PCML | Transmitter, receiver, and input reference clock pins of the high-speed transceivers use the PCML I/O standard. For transmitter, receiver, and reference clock I/O pin specifications, refer to Table 23 on page 18. | | | | | | | | | | | | | | |
| 2.5 V LVDS (1) | 2.375 | 2.5 | 2.625 | 100 | $V_{CM}$ = 1.25 V | — | 0.05 | $D_{MAX} \leq$ 700 Mbps | 1.8 | 0.247 | — | 0.6 | 1.125 | 1.25 | 1.375 |
| | | | | | | — | 1.05 | $D_{MAX} >$ 700 Mbps | 1.55 | 0.247 | — | 0.6 | 1.125 | 1.25 | 1.375 |
| BLVDS (5) | 2.375 | 2.5 | 2.625 | 100 | — | — | — | — | — | — | — | — | — | — | — |
| RSDS (HIO) (2) | 2.375 | 2.5 | 2.625 | 100 | $V_{CM}$ = 1.25 V | — | 0.3 | — | 1.4 | 0.1 | 0.2 | 0.6 | 0.5 | 1.2 | 1.4 |
| Mini-LVDS (HIO) (3) | 2.375 | 2.5 | 2.625 | 200 | — | 600 | 0.4 | — | 1.325 | 0.25 | — | 0.6 | 1 | 1.2 | 1.4 |
| LVPECL (4), (9) | — | — | — | 300 | — | — | 0.6 | $D_{MAX} \leq$ 700 Mbps | 1.8 | — | — | — | — | — | — |
| | — | — | — | 300 | — | — | 1 | $D_{MAX} >$ 700 Mbps | 1.6 | — | — | — | — | — | — |

**Notes to Table 22:**

(1) For optimized LVDS receiver performance, the receiver voltage input range must be between 1.0 V to 1.6 V for data rates above 700 Mbps, and 0 V to 1.85 V for data rates below 700 Mbps.

(2) For optimized RSDS receiver performance, the receiver voltage input range must be between 0.25 V to 1.45 V.

(3) For optimized Mini-LVDS receiver performance, the receiver voltage input range must be between 0.3 V to 1.425 V.

(4) For optimized LVPECL receiver performance, the receiver voltage input range must be between 0.85 V to 1.75 V for data rate above 700 Mbps and 0.45 V to 1.95 V for data rate below 700 Mbps.

(5) There are no fixed $V_{ICM}$, $V_{OD}$, and $V_{OCM}$ specifications for BLVDS. They depend on the system topology.

(6) RL range: $90 \leq RL \leq 110\ \Omega$ .

(7) The 1.4-V and 1.5-V PCML transceiver I/O standard specifications are described in "Transceiver Performance Specifications" on page 18.

(8) The minimum VID value is applicable over the entire common mode range, VCM.

(9) LVPECL is only supported on dedicated clock input pins.

(10) Differential inputs are powered by VCCPD which requires 2.5 V.

## Power Consumption

Altera offers two ways to estimate power consumption for a design—the Excel-based Early Power Estimator and the Quartus® II PowerPlay Power Analyzer feature.

You typically use the interactive Excel-based Early Power Estimator before designing the FPGA to get a magnitude estimate of the device power. The Quartus II PowerPlay Power Analyzer provides better quality estimates based on the specifics of the design after you complete place-and-route. The PowerPlay Power Analyzer can apply a combination of user-entered, simulation-derived, and estimated signal activities that, when combined with detailed circuit models, yields very accurate power estimates.

For more information about power estimation tools, refer to the *PowerPlay Early Power Estimator User Guide* and the *PowerPlay Power Analysis* chapter in the *Quartus II Handbook*.

**Table 23. Transceiver Specifications for Stratix V GX and GS Devices (1) (Part 3 of 7)**

| Symbol/ Description | Conditions | Transceiver Speed Grade 1 | | | Transceiver Speed Grade 2 | | | Transceiver Speed Grade 3 | | | Unit |
|---|---|---|---|---|---|---|---|---|---|---|---|
| | | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max | |
| Reconfiguration clock (mgmt_clk_clk) frequency | — | 100 | — | 125 | 100 | — | 125 | 100 | — | 125 | MHz |
| **Receiver** | | | | | | | | | | | |
| Supported I/O Standards | — | 1.4-V PCML, 1.5-V PCML, 2.5-V PCML, LVPECL, and LVDS | | | | | | | | | |
| Data rate (Standard PCS) (9), (23) | — | 600 | — | 12200 | 600 | — | 12200 | 600 | — | 8500/ 10312.5 (24) | Mbps |
| Data rate (10G PCS) (9), (23) | — | 600 | — | 14100 | 600 | — | 12500 | 600 | — | 8500/ 10312.5 (24) | Mbps |
| Absolute $V_{MAX}$ for a receiver pin (5) | — | — | — | 1.2 | — | — | 1.2 | — | — | 1.2 | V |
| Absolute $V_{MIN}$ for a receiver pin | — | –0.4 | — | — | –0.4 | — | — | –0.4 | — | — | V |
| Maximum peak-to-peak differential input voltage $V_{ID}$ (diff p-p) before device configuration (22) | — | — | — | 1.6 | — | — | 1.6 | — | — | 1.6 | V |
| Maximum peak-to-peak differential input voltage $V_{ID}$ (diff p-p) after device configuration (18), (22) | $V_{CCR\_GXB}$ = 1.0 V/1.05 V ($V_{ICM}$ = 0.70 V) | — | — | 2.0 | — | — | 2.0 | — | — | 2.0 | V |
| | $V_{CCR\_GXB}$ = 0.90 V ($V_{ICM}$ = 0.6 V) | — | — | 2.4 | — | — | 2.4 | — | — | 2.4 | V |
| | $V_{CCR\_GXB}$ = 0.85 V ($V_{ICM}$ = 0.6 V) | — | — | 2.4 | — | — | 2.4 | — | — | 2.4 | V |
| Minimum differential eye opening at receiver serial input pins (6), (22), (27) | — | 85 | — | — | 85 | — | — | 85 | — | — | mV |

Figure 2 shows the differential transmitter output waveform.

**Figure 2. Differential Transmitter Output Waveform**

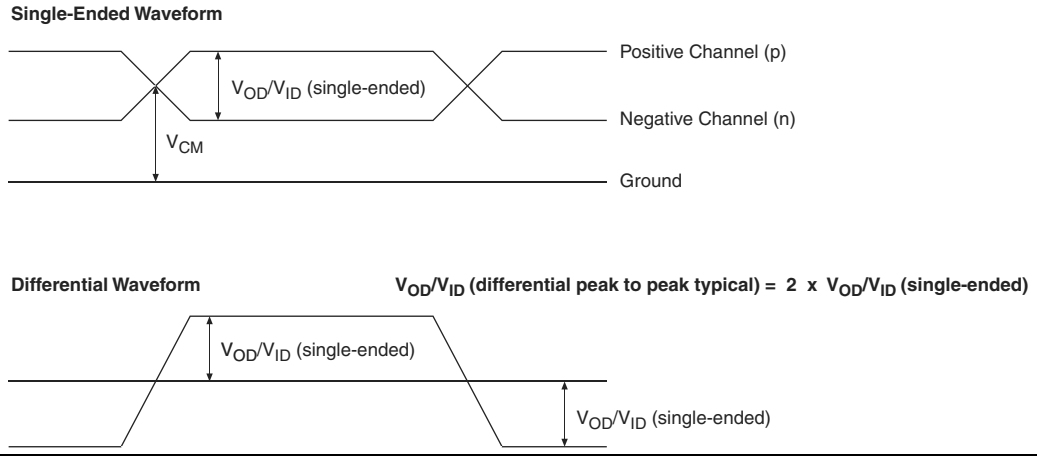



Figure 3 shows the Stratix V AC gain curves for GX channels.

**Figure 3. AC Gain Curves for GX Channels (full bandwidth)**

Stratix V GT devices contain both GX and GT channels. All transceiver specifications for the GX channels not listed in Table 28 are the same as those listed in Table 23.

Table 28 lists the Stratix V GT transceiver specifications.

**Table 28. Transceiver Specifications for Stratix V GT Devices (Part 2 of 5) (1)**

| Symbol/ Description | Conditions | Transceiver Speed Grade 2 | | | Transceiver Speed Grade 3 | | | Unit |
|---|---|---|---|---|---|---|---|---|
| | | Min | Typ | Max | Min | Typ | Max | |
| Transmitter REFCLK Phase Noise (622 MHz) (18) | 100 Hz | — | — | -70 | — | — | -70 | dBc/Hz |
| | 1 kHz | — | — | -90 | — | — | -90 | |
| | 10 kHz | — | — | -100 | — | — | -100 | |
| | 100 kHz | — | — | -110 | — | — | -110 | |
| | ≥ 1 MHz | — | — | -120 | — | — | -120 | |
| Transmitter REFCLK Phase Jitter (100 MHz) (15) | 10 kHz to 1.5 MHz (PCIe) | — | — | 3 | — | — | 3 | ps (rms) |
| RREF (17) | — | — | 1800 ± 1% | — | — | 1800 ± 1% | — | Ω |
| **Transceiver Clocks** | | | | | | | | |
| `fixedclk` clock frequency | PCIe Receiver Detect | — | 100 or 125 | — | — | 100 or 125 | — | MHz |
| Reconfiguration clock (`mgmt_clk_clk`) frequency | — | 100 | — | 125 | 100 | — | 125 | MHz |
| **Receiver** | | | | | | | | |
| Supported I/O Standards | — | 1.4-V PCML, 1.5-V PCML, 2.5-V PCML, LVPECL, and LVDS | | | | | | |
| Data rate (Standard PCS) (21) | GX channels | 600 | — | 8500 | 600 | — | 8500 | Mbps |
| Data rate (10G PCS) (21) | GX channels | 600 | — | 12,500 | 600 | — | 12,500 | Mbps |
| Data rate | GT channels | 19,600 | — | 28,050 | 19,600 | — | 25,780 | Mbps |
| Absolute $V_{MAX}$ for a receiver pin (3) | GT channels | — | — | 1.2 | — | — | 1.2 | V |
| Absolute $V_{MIN}$ for a receiver pin | GT channels | –0.4 | — | — | –0.4 | — | — | V |
| Maximum peak-to-peak differential input voltage $V_{ID}$ (diff p-p) before device configuration (20) | GT channels | — | — | 1.6 | — | — | 1.6 | V |
| | GX channels | (8) | | | | | | |
| Maximum peak-to-peak differential input voltage $V_{ID}$ (diff p-p) after device configuration (16), (20) | GT channels $V_{CCR\_GTB}$ = 1.05 V ($V_{ICM}$ = 0.65 V) | — | — | 2.2 | — | — | 2.2 | V |
| | GX channels | (8) | | | | | | |
| Minimum differential eye opening at receiver serial input pins (4), (20) | GT channels | 200 | — | — | 200 | — | — | mV |
| | GX channels | (8) | | | | | | |

Figure 4 shows the differential transmitter output waveform.

**Figure 4. Differential Transmitter/Receiver Output/Input Waveform**

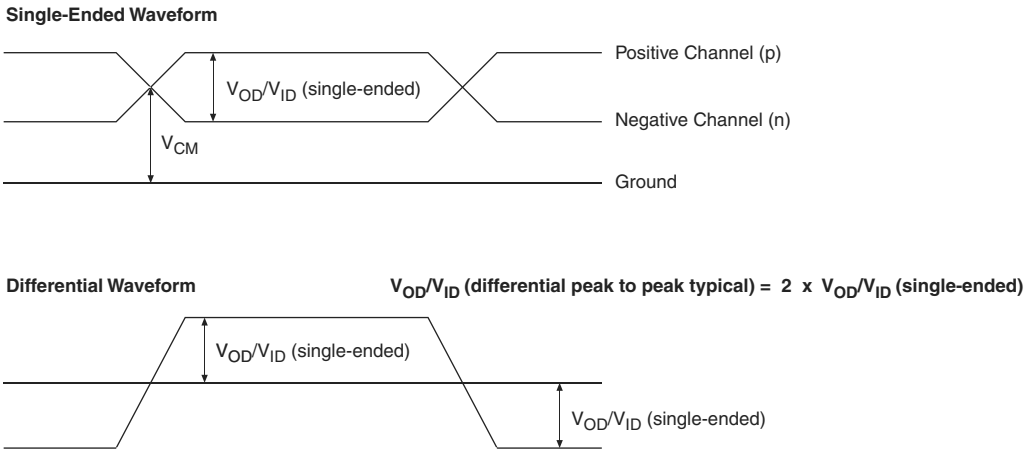



Figure 5 shows the Stratix V AC gain curves for GT channels.

**Figure 5. AC Gain Curves for GT Channels**

**Table 33. Memory Block Performance Specifications for Stratix V Devices (1), (2) (Part 2 of 2)**

| Memory | Mode | Resources Used | | Performance | | | | | | | Unit |
|---|---|---|---|---|---|---|---|---|---|---|---|
| | | ALUTs | Memory | C1 | C2, C2L | C3 | C4 | I2, I2L | I3, I3L, I3YY | I4 | |
| M20K Block | Single-port, all supported widths | 0 | 1 | 700 | 700 | 650 | 550 | 700 | 500 | 450 | MHz |
| | Simple dual-port, all supported widths | 0 | 1 | 700 | 700 | 650 | 550 | 700 | 500 | 450 | MHz |
| | Simple dual-port with the read-during-write option set to **Old Data**, all supported widths | 0 | 1 | 525 | 525 | 455 | 400 | 525 | 455 | 400 | MHz |
| | Simple dual-port with ECC enabled, 512 × 32 | 0 | 1 | 450 | 450 | 400 | 350 | 450 | 400 | 350 | MHz |
| | Simple dual-port with ECC and optional pipeline registers enabled, 512 × 32 | 0 | 1 | 600 | 600 | 500 | 450 | 600 | 500 | 450 | MHz |
| | True dual port, all supported widths | 0 | 1 | 700 | 700 | 650 | 550 | 700 | 500 | 450 | MHz |
| | ROM, all supported widths | 0 | 1 | 700 | 700 | 650 | 550 | 700 | 500 | 450 | MHz |

**Notes to Table 33:**

(1) To achieve the maximum memory block performance, use a memory block clock that comes through global clock routing from an on-chip PLL set to **50%** output duty cycle. Use the Quartus II software to report timing for this and other memory block clocking schemes.

(2) When you use the error detection cyclical redundancy check (CRC) feature, there is no degradation in $F_{MAX}$.

(3) The $F_{MAX}$ specification is only achievable with Fitter options, **MLAB Implementation In 16-Bit Deep Mode** enabled.

## Temperature Sensing Diode Specifications

Table 34 lists the internal TSD specification.

**Table 34. Internal Temperature Sensing Diode Specification**

| Temperature Range | Accuracy | Offset Calibrated Option | Sampling Rate | Conversion Time | Resolution | Minimum Resolution with no Missing Codes |
|---|---|---|---|---|---|---|
| –40°C to 100°C | ±8°C | No | 1 MHz, 500 KHz | < 100 ms | 8 bits | 8 bits |

Table 35 lists the specifications for the Stratix V external temperature sensing diode.

**Table 35. External Temperature Sensing Diode Specifications for Stratix V Devices**

| Description | Min | Typ | Max | Unit |
|---|---|---|---|---|
| $I_{bias}$, diode source current | 8 | — | 200 | μA |
| $V_{bias,}$ voltage across diode | 0.3 | — | 0.9 | V |
| Series resistance | — | — | < 1 | Ω |
| Diode ideality factor | 1.006 | 1.008 | 1.010 | — |

# Periphery Performance

This section describes periphery performance, including high-speed I/O and external memory interface.

I/O performance supports several system interfaces, such as the **LVDS** high-speed I/O interface, external memory interface, and the **PCI/PCI-X** bus interface. General-purpose I/O standards such as 3.3-, 2.5-, 1.8-, and 1.5-**LVTTL/LVCMOS** are capable of a typical 167 MHz and 1.2-**LVCMOS** at 100 MHz interfacing frequency with a 10 pF load.

☞ The actual achievable frequency depends on design- and system-specific factors. Ensure proper timing closure in your design and perform HSPICE/IBIS simulations based on your specific design and system setup to determine the maximum achievable frequency in your system.

## High-Speed I/O Specification

Table 36 lists high-speed I/O timing for Stratix V devices.

**Table 36. High-Speed I/O Specifications for Stratix V Devices (1), (2) (Part 1 of 4)**

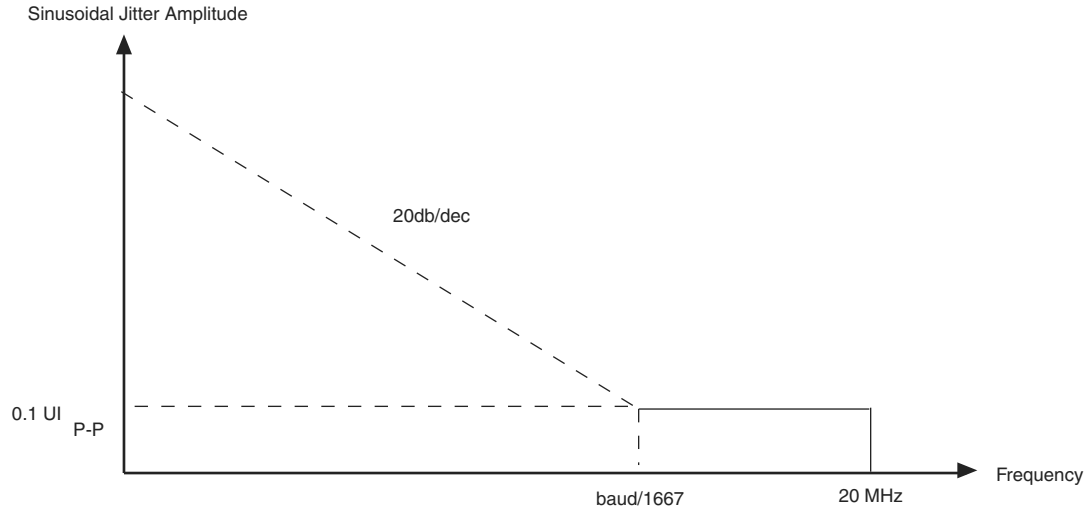
| Symbol | Conditions | C1 | | | C2, C2L, I2, I2L | | | C3, I3, I3L, I3YY | | | C4,I4 | | | Unit |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| | | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max | |
| $f_{HSCLK\_in}$ (input clock frequency) True Differential I/O Standards | Clock boost factor W = 1 to 40 (4) | 5 | — | 800 | 5 | — | 800 | 5 | — | 625 | 5 | — | 525 | MHz |
| $f_{HSCLK\_in}$ (input clock frequency) Single Ended I/O Standards (3) | Clock boost factor W = 1 to 40 (4) | 5 | — | 800 | 5 | — | 800 | 5 | — | 625 | 5 | — | 525 | MHz |
| $f_{HSCLK\_in}$ (input clock frequency) Single Ended I/O Standards | Clock boost factor W = 1 to 40 (4) | 5 | — | 520 | 5 | — | 520 | 5 | — | 420 | 5 | — | 420 | MHz |
| $f_{HSCLK\_OUT}$ (output clock frequency) | — | 5 | — | 800 | 5 | — | 800 | 5 | — | 625 (5) | 5 | — | 525 (5) | MHz |

**Table 38. LVDS Soft-CDR/DPA Sinusoidal Jitter Mask Values for a Data Rate ≥ 1.25 Gbps**

| Jitter Frequency (Hz) | | Sinusoidal Jitter (UI) |
|---|---|---|
| F1 | 10,000 | 25.000 |
| F2 | 17,565 | 25.000 |
| F3 | 1,493,000 | 0.350 |
| F4 | 50,000,000 | 0.350 |

Figure 9 shows the **LVDS** soft-CDR/DPA sinusoidal jitter tolerance specification for a data rate < 1.25 Gbps.

**Figure 9. LVDS Soft-CDR/DPA Sinusoidal Jitter Tolerance Specification for a Data Rate < 1.25 Gbps**




## DLL Range, DQS Logic Block, and Memory Output Clock Jitter Specifications

Table 39 lists the DLL range specification for Stratix V devices. The DLL is always in 8-tap mode in Stratix V devices.

**Table 39. DLL Range Specifications for Stratix V Devices (1)**

| C1 | C2, C2L, I2, I2L | C3, I3, I3L, I3YY | C4,I4 | Unit |
|---|---|---|---|---|
| 300-933 | 300-933 | 300-890 | 300-890 | MHz |

**Note to Table 39:**

(1) Stratix V devices support memory interface frequencies lower than 300 MHz, although the reference clock that feeds the DLL must be at least 300 MHz. To support interfaces below 300 MHz, multiply the reference clock feeding the DLL to ensure the frequency is within the supported range of the DLL.

Table 40 lists the DQS phase offset delay per stage for Stratix V devices.

**Table 40. DQS Phase Offset Delay Per Setting for Stratix V Devices (1), (2) (Part 1 of 2)**

| Speed Grade | Min | Max | Unit |
|---|---|---|---|
| C1 | 8 | 14 | ps |
| C2, C2L, I2, I2L | 8 | 14 | ps |
| C3,I3, I3L, I3YY | 8 | 15 | ps |

**Table 42. Memory Output Clock Jitter Specification for Stratix V Devices (1), (Part 2 of 2) (2), (3)**

| Clock Network | Parameter | Symbol | C1 | | C2, C2L, I2, I2L | | C3, I3, I3L, I3YY | | C4,I4 | | Unit |
|---|---|---|---|---|---|---|---|---|---|---|---|
| | | | Min | Max | Min | Max | Min | Max | Min | Max | |
| PHY Clock | Clock period jitter | $t_{JIT(per)}$ | –25 | 25 | –25 | 25 | –30 | 30 | –35 | 35 | ps |
| | Cycle-to-cycle period jitter | $t_{JIT(cc)}$ | –50 | 50 | –50 | 50 | –60 | 60 | –70 | 70 | ps |
| | Duty cycle jitter | $t_{JIT(duty)}$ | –37.5 | 37.5 | –37.5 | 37.5 | –45 | 45 | –56 | 56 | ps |

**Notes to Table 42:**

(1) The clock jitter specification applies to the memory output clock pins generated using differential signal-splitter and DDIO circuits clocked by a PLL output routed on a PHY, regional, or global clock network as specified. Altera recommends using PHY clock networks whenever possible.

(2) The clock jitter specification applies to the memory output clock pins clocked by an integer PLL.

(3) The memory output clock jitter is applicable when an input jitter of 30 ps peak-to-peak is applied with bit error rate (BER) -12, equivalent to 14 sigma.

## OCT Calibration Block Specifications

Table 43 lists the OCT calibration block specifications for Stratix V devices.

**Table 43. OCT Calibration Block Specifications for Stratix V Devices**

| Symbol | Description | Min | Typ | Max | Unit |
|---|---|---|---|---|---|
| OCTUSRCLK | Clock required by the OCT calibration blocks | — | — | 20 | MHz |
| $T_{OCTCAL}$ | Number of OCTUSRCLK clock cycles required for OCT $R_S/R_T$ calibration | — | 1000 | — | Cycles |
| $T_{OCTSHIFT}$ | Number of OCTUSRCLK clock cycles required for the OCT code to shift out | — | 32 | — | Cycles |
| $T_{RS\_RT}$ | Time required between the `dyn_term_ctrl` and `oe` signal transitions in a bidirectional I/O buffer to dynamically switch between OCT $R_S$ and $R_T$ (Figure 10) | — | 2.5 | — | ns |

Figure 10 shows the timing diagram for the `oe` and `dyn_term_ctrl` signals.

**Figure 10. Timing Diagram for oe and dyn_term_ctrl Signals**

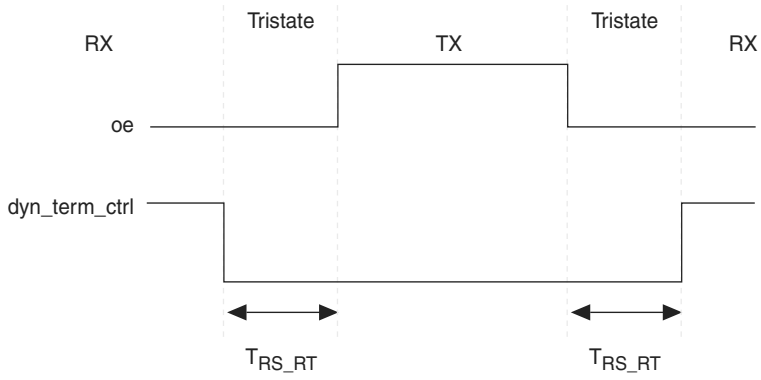


**Table 47. Uncompressed .rbf Sizes for Stratix V Devices**

| Family | Device | Package | Configuration .rbf Size (bits) | IOCSR .rbf Size (bits) (4), (5) |
|---|---|---|---|---|
| Stratix V E (1) | 5SEE9 | — | 342,742,976 | 700,888 |
| | 5SEEB | — | 342,742,976 | 700,888 |

**Notes to Table 47:**

(1) Stratix V E devices do not have PCI Express® (PCIe®) hard IP. Stratix V E devices do not support the CvP configuration scheme.
(2) 36-transceiver devices.
(3) 24-transceiver devices.
(4) File size for the periphery image.
(5) The IOCSR **.rbf** size is specifically for the CvP feature.

Use the data in Table 47 to estimate the file size before design compilation. Different configuration file formats, such as a hexadecimal (**.hex**) or tabular text file (**.ttf**) format, have different file sizes. For the different types of configuration file and file sizes, refer to the Quartus II software. However, for a specific version of the Quartus II software, any design targeted for the same device has the same uncompressed configuration file size. If you are using compression, the file size can vary after each compilation because the compression ratio depends on your design.

For more information about setting device configuration options, refer to *Configuration, Design Security, and Remote System Upgrades in Stratix V Devices*. For creating configuration files, refer to the *Quartus II Help*.

Table 48 lists the minimum configuration time estimates for Stratix V devices.

**Table 48. Minimum Configuration Time Estimation for Stratix V Devices**

| Variant | Member Code | Active Serial (1) | | | Fast Passive Parallel (2) | | |
|---|---|---|---|---|---|---|---|
| | | Width | DCLK (MHz) | Min Config Time (s) | Width | DCLK (MHz) | Min Config Time (s) |
| GX | A3 | 4 | 100 | 0.534 | 32 | 100 | 0.067 |
| | | 4 | 100 | 0.344 | 32 | 100 | 0.043 |
| | A4 | 4 | 100 | 0.534 | 32 | 100 | 0.067 |
| | A5 | 4 | 100 | 0.675 | 32 | 100 | 0.084 |
| | A7 | 4 | 100 | 0.675 | 32 | 100 | 0.084 |
| | A9 | 4 | 100 | 0.857 | 32 | 100 | 0.107 |
| | AB | 4 | 100 | 0.857 | 32 | 100 | 0.107 |
| | B5 | 4 | 100 | 0.676 | 32 | 100 | 0.085 |
| | B6 | 4 | 100 | 0.676 | 32 | 100 | 0.085 |
| | B9 | 4 | 100 | 0.857 | 32 | 100 | 0.107 |
| | BB | 4 | 100 | 0.857 | 32 | 100 | 0.107 |
| GT | C5 | 4 | 100 | 0.675 | 32 | 100 | 0.084 |
| | C7 | 4 | 100 | 0.675 | 32 | 100 | 0.084 |

**Table 48. Minimum Configuration Time Estimation for Stratix V Devices**

| Variant | Member Code | Active Serial (1) | | | Fast Passive Parallel (2) | | |
|---|---|---|---|---|---|---|---|
| | | Width | DCLK (MHz) | Min Config Time (s) | Width | DCLK (MHz) | Min Config Time (s) |
| GS | D3 | 4 | 100 | 0.344 | 32 | 100 | 0.043 |
| | D4 | 4 | 100 | 0.534 | 32 | 100 | 0.067 |
| | | 4 | 100 | 0.344 | 32 | 100 | 0.043 |
| | D5 | 4 | 100 | 0.534 | 32 | 100 | 0.067 |
| | D6 | 4 | 100 | 0.741 | 32 | 100 | 0.093 |
| | D8 | 4 | 100 | 0.741 | 32 | 100 | 0.093 |
| E | E9 | 4 | 100 | 0.857 | 32 | 100 | 0.107 |
| | EB | 4 | 100 | 0.857 | 32 | 100 | 0.107 |

**Notes to Table 48:**

(1) DCLK frequency of 100 MHz using external CLKUSR.

(2) Max FPGA FPP bandwidth may exceed bandwidth available from some external storage or control logic.

# Fast Passive Parallel Configuration Timing

This section describes the fast passive parallel (FPP) configuration timing parameters for Stratix V devices.

## DCLK-to-DATA[] Ratio for FPP Configuration

FPP configuration requires a different DCLK-to-DATA[] ratio when you enable the design security, decompression, or both features. Table 49 lists the DCLK-to-DATA[] ratio for each combination.

**Table 49. DCLK-to-DATA[] Ratio (1) (Part 1 of 2)**

| Configuration Scheme | Decompression | Design Security | DCLK-to-DATA[] Ratio |
|---|---|---|---|
| FPP ×8 | Disabled | Disabled | 1 |
| | Disabled | Enabled | 1 |
| | Enabled | Disabled | 2 |
| | Enabled | Enabled | 2 |
| FPP ×16 | Disabled | Disabled | 1 |
| | Disabled | Enabled | 2 |
| | Enabled | Disabled | 4 |
| | Enabled | Enabled | 4 |

**Table 49. DCLK-to-DATA[] Ratio (1) (Part 2 of 2)**

| Configuration Scheme | Decompression | Design Security | DCLK-to-DATA[] Ratio |
|---|---|---|---|
| FPP ×32 | Disabled | Disabled | 1 |
| | Disabled | Enabled | 4 |
| | Enabled | Disabled | 8 |
| | Enabled | Enabled | 8 |

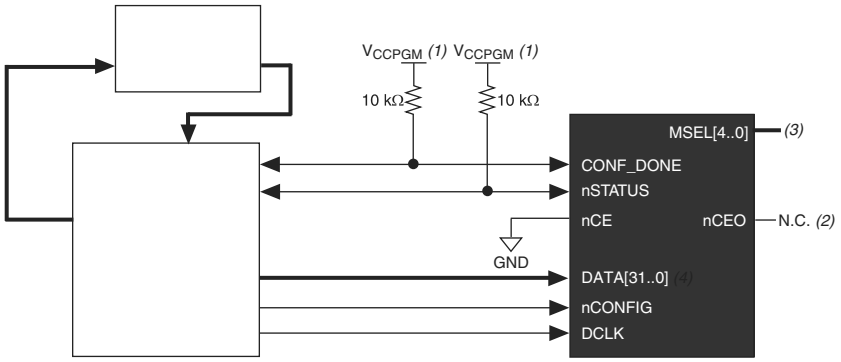
**Note to Table 49:**

(1) Depending on the DCLK-to-DATA[] ratio, the host must send a DCLK frequency that is r times the data rate in bytes per second (Bps), or words per second (Wps). For example, in FPP ×16 when the DCLK-to-DATA[] ratio is 2, the DCLK frequency must be 2 times the data rate in Wps. Stratix V devices use the additional clock cycles to decrypt and decompress the configuration data.

If the DCLK-to-DATA[] ratio is greater than 1, at the end of configuration, you can only stop the DCLK (DCLK-to-DATA[] ratio – 1) clock cycles after the last data is latched into the Stratix V device.

Figure 11 shows the configuration interface connections between the Stratix V device and a MAX II or MAX V device for single device configuration.

**Figure 11. Single Device FPP Configuration Using an External Host**




**Notes to Figure 11:**

(1) Connect the resistor to a supply that provides an acceptable input signal for the Stratix V device. $V_{CCPGM}$ must be high enough to meet the $V_{IH}$ specification of the I/O on the device and the external host. Altera recommends powering up all configuration system I/Os with $V_{CCPGM}$.

(2) You can leave the nCEO pin unconnected or use it as a user I/O pin when it does not feed another device's nCE pin.

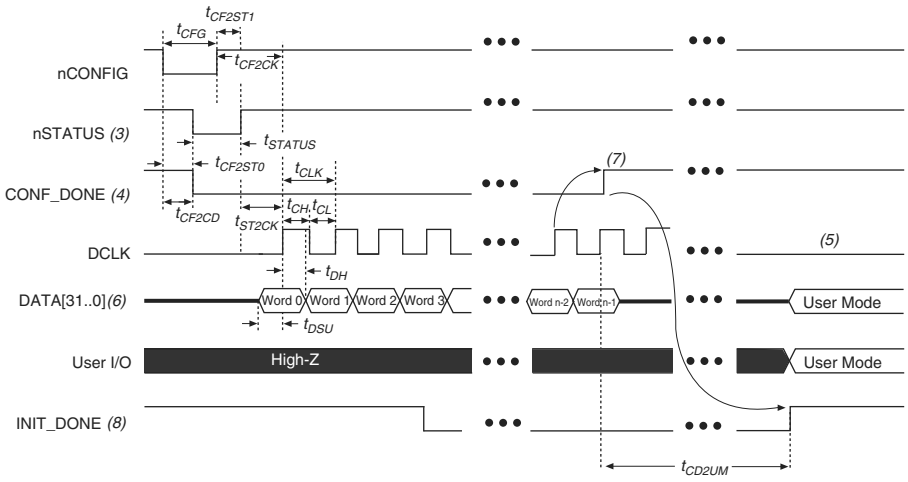
(3) The MSEL pin settings vary for different data width, configuration voltage standards, and POR delay. To connect MSEL, refer to the MSEL Pin Settings section of the "Configuration, Design Security, and Remote System Upgrades in Stratix V Devices" chapter.

(4) If you use FPP ×8, use DATA[7..0]. If you use FPP ×16, use DATA[15..0].

## FPP Configuration Timing when DCLK-to-DATA [] = 1

Figure 12 shows the timing waveform for FPP configuration when using a MAX II or MAX V device as an external host. This waveform shows timing when the DCLK-to-DATA[] ratio is 1.

**Figure 12. FPP Configuration Timing Waveform When the DCLK-to-DATA[] Ratio is 1** *(1), (2)*




**Notes to Figure 12:**

(1) Use this timing waveform when the DCLK-to-DATA[] ratio is 1.

(2) The beginning of this waveform shows the device in user mode. In user mode, nCONFIG, nSTATUS, and CONF_DONE are at logic-high levels. When nCONFIG is pulled low, a reconfiguration cycle begins.

(3) After power-up, the Stratix V device holds nSTATUS low for the time of the POR delay.

(4) After power-up, before and during configuration, CONF_DONE is low.

(5) Do not leave DCLK floating after configuration. DCLK is ignored after configuration is complete. It can toggle high or low if required.

(6) For FPP ×16, use DATA[15..0]. For FPP ×8, use DATA[7..0]. DATA[31..0] are available as a user I/O pin after configuration. The state of this pin depends on the dual-purpose pin settings.

(7) To ensure a successful configuration, send the entire configuration data to the Stratix V device. CONF_DONE is released high when the Stratix V device receives all the configuration data successfully. After CONF_DONE goes high, send two additional falling edges on DCLK to begin initialization and enter user mode.

(8) After the option bit to enable the INIT_DONE pin is configured into the device, the INIT_DONE goes low.

# Document Revision History

Table 61 lists the revision history for this chapter.

**Table 61. Document Revision History (Part 1 of 3)**

| Date | Version | Changes |
|---|---|---|
| June 2018 | 3.9 | ■ Added the “Stratix V Device Overshoot Duration” figure. |
| April 2017 | 3.8 | ■ Added a footnote to the “High-Speed I/O Specifications for Stratix V Devices” table.<br>■ Changed the minimum value for $t_{CD2UMC}$ in the “PS Timing Parameters for Stratix V Devices” table.<br>■ Changed the condition for 100-Ω $R_D$ in the “OCT Without Calibration Resistance Tolerance Specifications for Stratix V Devices” table.<br>■ Changed the minimum value for $t_{CD2UMC}$ in the “AS Timing Parameters for AS ´1 and AS ´4 Configurations in Stratix V Devices” table<br>■ Changed the minimum value for $t_{CD2UMC}$ in the “FPP Timing Parameters for Stratix V Devices When the DCLK-to-DATA[] Ratio is >1” table.<br>■ Changed the minimum value for $t_{CD2UMC}$ in the “FPP Timing Parameters for Stratix V Devices When the DCLK-to-DATA[] Ratio is >1” table.<br>■ Changed the minimum number of clock cycles value in the “Initialization Clock Source Option and the Maximum Frequency” table. |
| June 2016 | 3.7 | ■ Added the $V_{ID}$ minimum specification for LVPECL in the “Differential I/O Standard Specifications for Stratix V Devices” table<br>■ Added the $I_{OUT}$ specification to the “Absolute Maximum Ratings for Stratix V Devices” table. |
| December 2015 | 3.6 | ■ Added a footnote to the “High-Speed I/O Specifications for Stratix V Devices” table. |
| December 2015 | 3.5 | ■ Changed the transmitter, receiver, and ATX PLL data rate specifications in the “Transceiver Specifications for Stratix V GX and GS Devices” table.<br>■ Changed the configuration .rbf sizes in the “Uncompressed .rbf Sizes for Stratix V Devices” table. |
| July 2015 | 3.4 | ■ Changed the data rate specification for transceiver speed grade 3 in the following tables:<br>  ■ “Transceiver Specifications for Stratix V GX and GS Devices”<br>  ■ “Stratix V Standard PCS Approximate Maximum Date Rate”<br>  ■ “Stratix V 10G PCS Approximate Maximum Data Rate”<br>■ Changed the conditions for reference clock rise and fall time, and added a note to the “Transceiver Specifications for Stratix V GX and GS Devices” table.<br>■ Added a note to the “Minimum differential eye opening at receiver serial input pins” specification in the “Transceiver Specifications for Stratix V GX and GS Devices” table.<br>■ Changed the $t_{CO}$ maximum value in the “AS Timing Parameters for AS ´1 and AS ´4 Configurations in Stratix V Devices” table.<br>■ Removed the CDR ppm tolerance specification from the “Transceiver Specifications for Stratix V GX and GS Devices” table. |

**Table 61. Document Revision History (Part 2 of 3)**

| Date | Version | Changes |
|---|---|---|
| November 2014 | 3.3 | ■ Added the I3YY speed grade and changed the data rates for the GX channel in Table 1.<br>■ Added the I3YY speed grade to the $V_{CC}$ description in Table 6.<br>■ Added the I3YY speed grade to $V_{CCHIP\_L}$, $V_{CCHIP\_R}$, $V_{CCHSSI\_L}$, and $V_{CCHSSI\_R}$ descriptions in Table 7.<br>■ Added 240-Ω to Table 11.<br>■ Changed CDR PPM tolerance in Table 23.<br>■ Added additional max data rate for fPLL in Table 23.<br>■ Added the I3YY speed grade and changed the data rates for transceiver speed grade 3 in Table 25.<br>■ Added the I3YY speed grade and changed the data rates for transceiver speed grade 3 in Table 26.<br>■ Changed CDR PPM tolerance in Table 28.<br>■ Added additional max data rate for fPLL in Table 28.<br>■ Changed the mode descriptions for MLAB and M20K in Table 33.<br>■ Changed the Max value of $f_{HSCLK\_OUT}$ for the C2, C2L, I2, I2L speed grades in Table 36.<br>■ Changed the frequency ranges for C1 and C2 in Table 39.<br>■ Changed the **.rbf** file sizes for 5SGSD6 and 5SGSD8 in Table 47.<br>■ Added note about `nSTATUS` to Table 50, Table 51, Table 54.<br>■ Changed the available settings in Table 58.<br>■ Changed the note in “Periphery Performance”.<br>■ Updated the “I/O Standard Specifications” section.<br>■ Updated the “Raw Binary File Size” section.<br>■ Updated the receiver voltage input range in Table 22.<br>■ Updated the max frequency for the LVDS clock network in Table 36.<br>■ Updated the `DCLK` note to Figure 11.<br>■ Updated Table 23 $VO_{CM}$ (DC Coupled) condition.<br>■ Updated Table 6 and Table 7.<br>■ Added the `DCLK` specification to Table 55.<br>■ Updated the notes for Table 47.<br>■ Updated the list of parameters for Table 56. |
| November 2013 | 3.2 | ■ Updated Table 28 |
| November 2013 | 3.1 | ■ Updated Table 33 |
| November 2013 | 3.0 | ■ Updated Table 23 and Table 28 |
| October 2013 | 2.9 | ■ Updated the “Transceiver Characterization” section |
| October 2013 | 2.8 | ■ Updated Table 3, Table 12, Table 14, Table 19, Table 20, Table 23, Table 24, Table 28, Table 30, Table 31, Table 32, Table 33, Table 36, Table 39, Table 40, Table 41, Table 42, Table 47, Table 53, Table 58, and Table 59<br>■ Added Figure 1 and Figure 3<br>■ Added the “Transceiver Characterization” section<br>■ Removed all “Preliminary” designations. |

**Table 61. Document Revision History (Part 3 of 3)**

| Date | Version | Changes |
|---|---|---|
| May 2013 | 2.7 | ■ Updated Table 2, Table 6, Table 7, Table 20, Table 23, Table 27, Table 47, Table 60<br>■ Added Table 24, Table 48<br>■ Updated Figure 9, Figure 10, Figure 11, Figure 12 |
| February 2013 | 2.6 | ■ Updated Table 7, Table 9, Table 20, Table 23, Table 27, Table 30, Table 31, Table 35, Table 46<br>■ Updated "Maximum Allowed Overshoot and Undershoot Voltage" |
| December 2012 | 2.5 | ■ Updated Table 3, Table 6, Table 7, Table 8, Table 23, Table 24, Table 25, Table 27, Table 30, Table 32, Table 35<br>■ Added Table 33<br>■ Added "Fast Passive Parallel Configuration Timing"<br>■ Added "Active Serial Configuration Timing"<br>■ Added "Passive Serial Configuration Timing"<br>■ Added "Remote System Upgrades"<br>■ Added "User Watchdog Internal Circuitry Timing Specification"<br>■ Added "Initialization"<br>■ Added "Raw Binary File Size" |
| June 2012 | 2.4 | ■ Added Figure 1, Figure 2, and Figure 3.<br>■ Updated Table 1, Table 2, Table 3, Table 6, Table 11, Table 22, Table 23, Table 27,Table 29, Table 30, Table 31, Table 32, Table 35, Table 38, Table 39, Table 40, Table 41, Table 43, Table 56, and Table 59.<br>■ Various edits throughout to fix bugs.<br>■ Changed title of document to *Stratix V Device Datasheet*.<br>■ Removed document from the Stratix V handbook and made it a separate document. |
| February 2012 | 2.3 | ■ Updated Table 1–22, Table 1–29, Table 1–31, and Table 1–31. |
| December 2011 | 2.2 | ■ Added Table 2–31.<br>■ Updated Table 2–28 and Table 2–34. |
| November 2011 | 2.1 | ■ Added Table 2–2 and Table 2–21 and updated Table 2–5 with information about Stratix V GT devices.<br>■ Updated Table 2–11, Table 2–13, Table 2–20, and Table 2–25.<br>■ Various edits throughout to fix SPRs. |
| May 2011 | 2.0 | ■ Updated Table 2–4, Table 2–18, Table 2–19, Table 2–21, Table 2–22, Table 2–23, and Table 2–24.<br>■ Updated the "DQ Logic Block and Memory Output Clock Jitter Specifications" title.<br>■ Chapter moved to Volume 1.<br>■ Minor text edits. |
| December 2010 | 1.1 | ■ Updated Table 1–2, Table 1–4, Table 1–19, and Table 1–23.<br>■ Converted chapter to the new template.<br>■ Minor text edits. |
| July 2010 | 1.0 | Initial release. |